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United States Patent [19]

Hayashi

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[54]	EARPHONE COMBINED WITH MICROPHONE		
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[**]	Term:	14 Y	ears
[21]	Appl. No.: 43,818		
[22]	Filed:	Sep.	13, 1995
[52]	U.S. Cl	_	
[58]	Field of Search		
	D14/147-148, 192, 205-206, 223, 249;		
	181/129–130, 137; 379/430, 431, 444;		
381/25, 68, 68.6, 68.7, 69, 151, 158, 183, 187			
[56] References Cited			
U.S. PATENT DOCUMENTS			
	,	7/1993 9/1994	Seikita

FOREIGN PATENT DOCUMENTS

[57] CLAIM

The ornamental design for an earphone combined with microphone, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of an earphone combined with microphone showing my new design;

FIG. 2 is a top plan view thereof;

FIG. 3 is a left side elevational view thereof;

FIG. 4 is a front elevational view thereof;

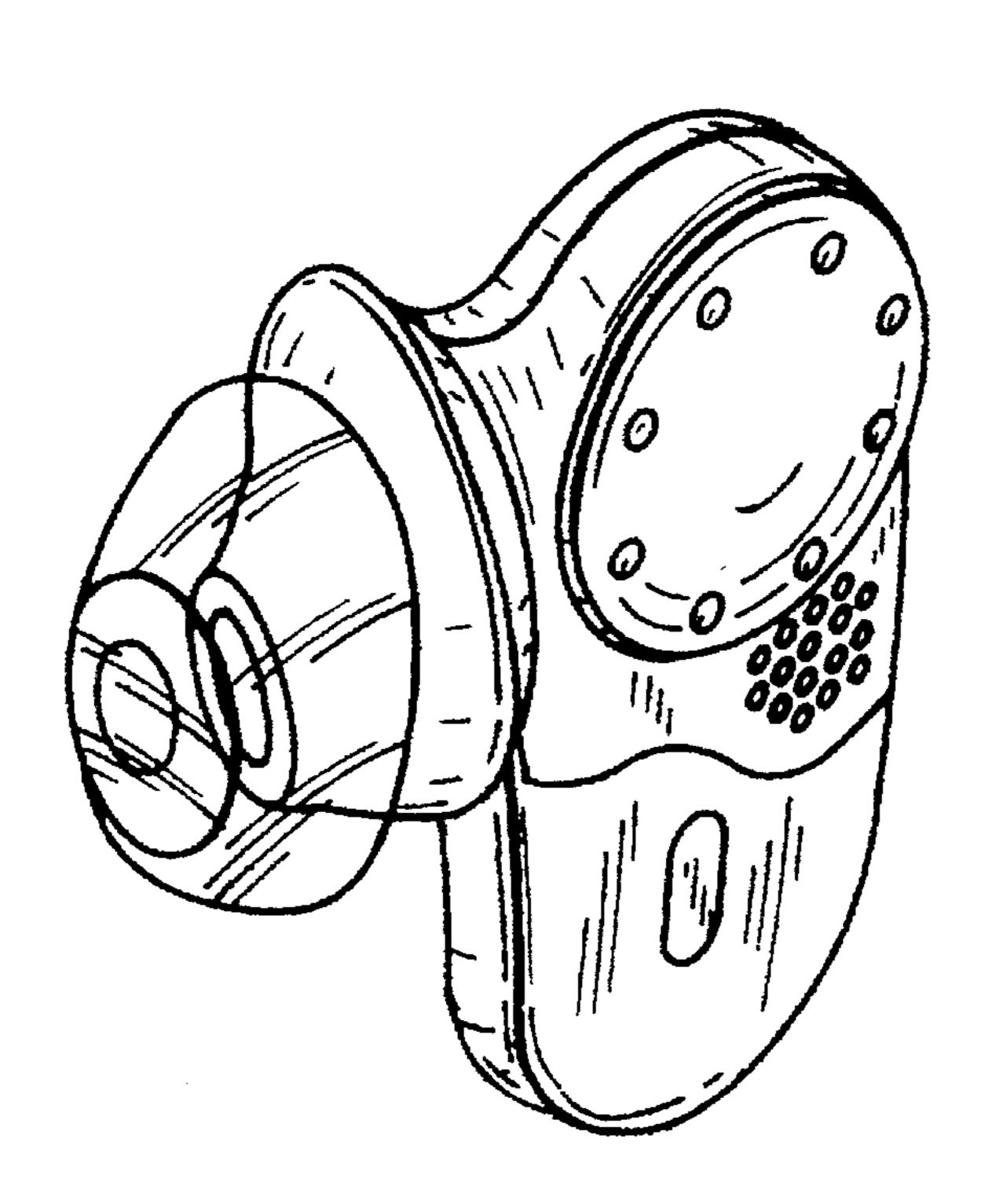
FIG. 5 is a right side elevational view thereof;

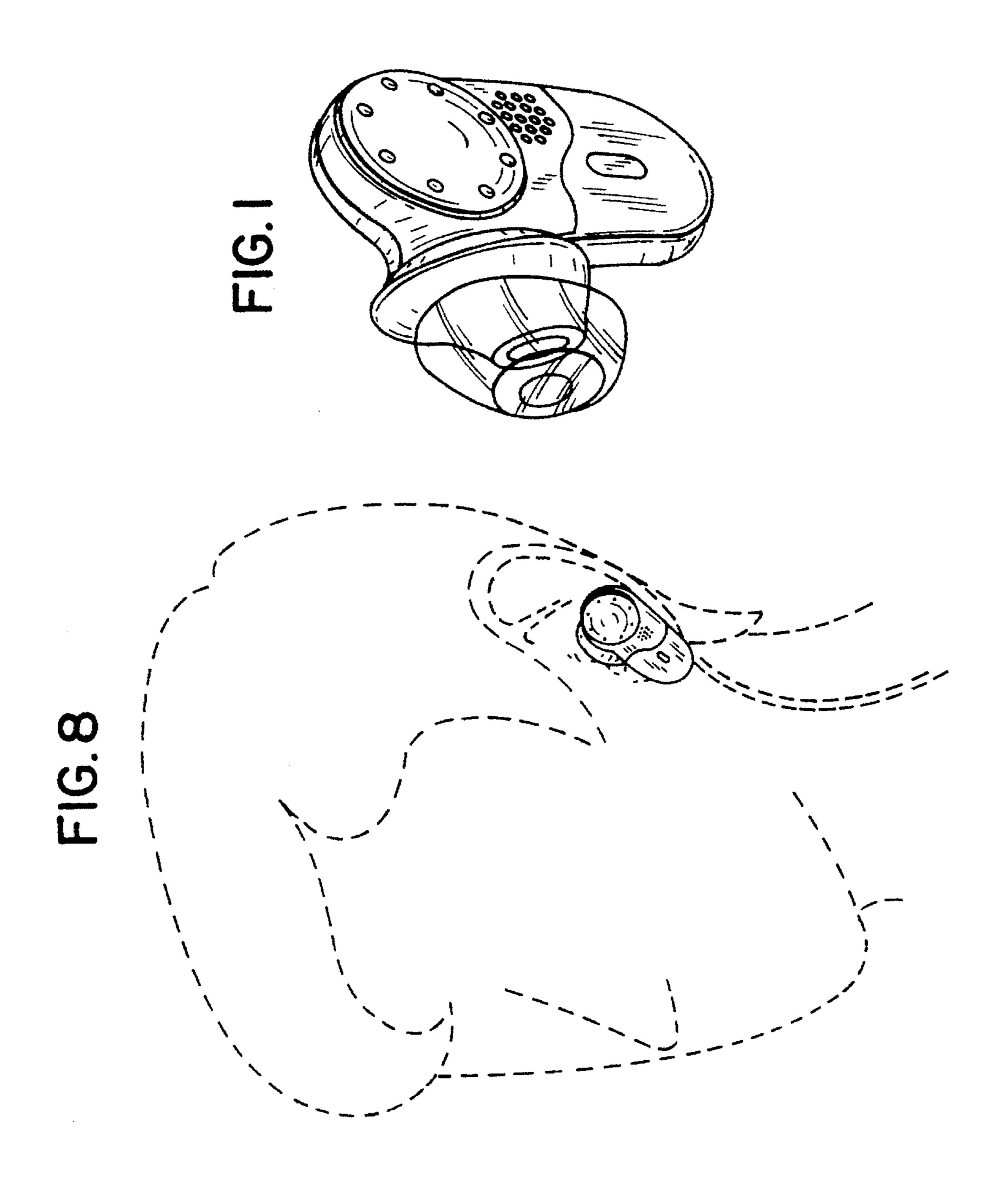
FIG. 6 is a rear elevational view thereof;

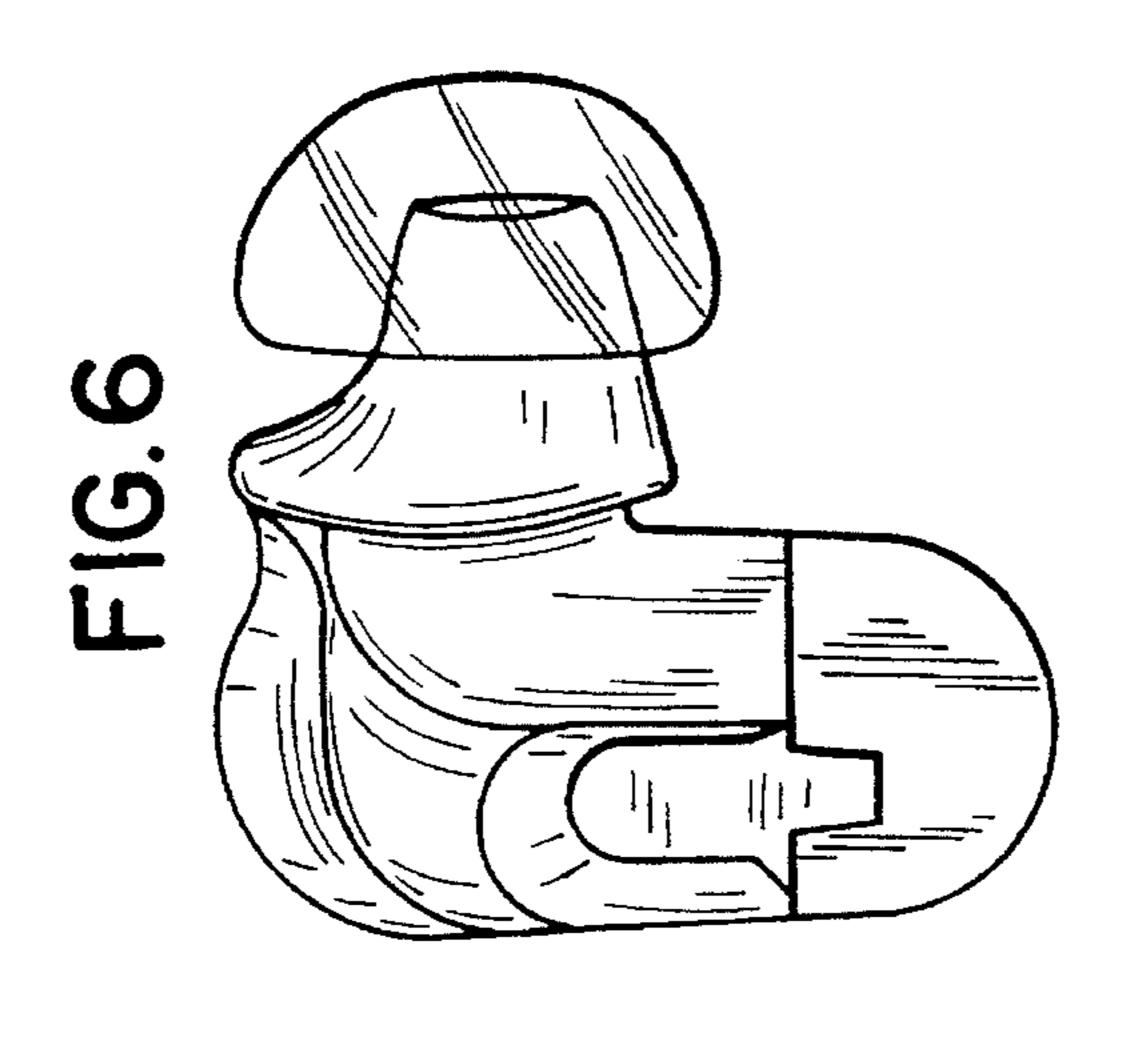
FIG. 7 is a bottom plan view thereof; and,

FIG. 8 is a view of the earphone in use wherein the person having the earphone is shown in broken lines for illustrative purposes only and forms no part of the claimed design.

1 Claim, 2 Drawing Sheets







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